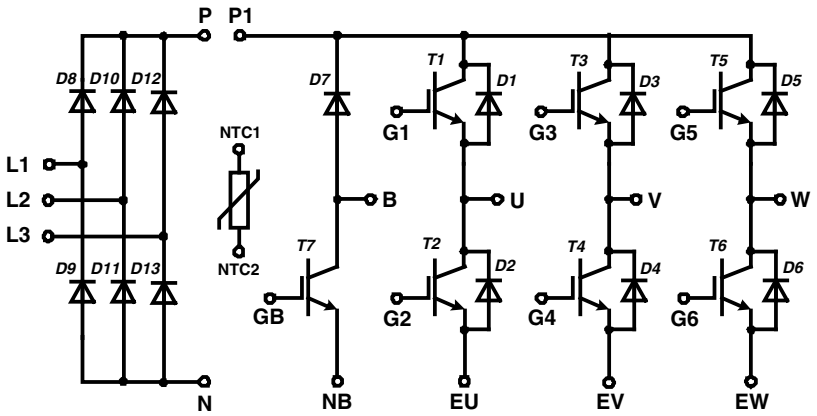
Converter - Brake - Inverter Module
XPT IGBT

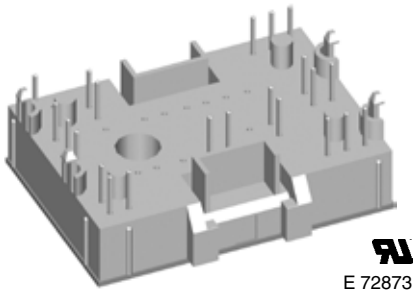
Three Phase Rectifier	Brake Chopper	Three Phase Inverter
V_{RRM} = 1600 V	V_{CES} = 1200 V	V_{CES} = 1200 V
I_{DAVM25} = 100 A	I_{C25} = 17 A	I_{C25} = 17 A
I_{FSM} = 270 A	$V_{CE(sat)}$ = 1.8 V	$V_{CE(sat)}$ = 1.8 V

Preliminary data

Part name (Marking on product)

MIXA10WB1200TMH





E 72873

Pin configuration see outlines.

Features:

- High level of integration - only one power semiconductor module required for the whole drive
- Rugged XPT design (Xtreme light Punch Through) results in:
  - short circuit rated for 10 µsec.
  - very low gate charge
  - square RBSOA @ 3x I_C
  - low EMI
- Thin wafer technology combined with the XPT design results in a competitive low $V_{CE(sat)}$
- Temperature sense included
- SONIC™ diode
  - fast and soft reverse recovery
  - low operating forward voltage

Application:

- AC motor drives
- Pumps, Fans
- Washing machines
- Air-conditioning system
- Inverter and power supplies

Package:

- "Mini" package
- Assembly height is 17 mm
- Insulated base plate
- Pins suitable for wave soldering and PCB mounting
- Assembly clips available
  - IXKU 5-505 screw clamp
  - IXRB 5-506 click clamp
- UL registered E72873

Ouput Inverter T1 - T6

Symbol	Definitions	Conditions		min.	Ratings typ.	max.	Unit
V_{CES}	*collector emitter voltage*		T_{VJ} = 25°C			1200	V
V_{GES}	*max. DC gate voltage*	continuous				±20	V
V_{GEM}	*max. transient collector gate voltage*	transient				±30	V
I_{C25}	*collector current*		T_C = 25°C			17	A
I_{C80}			T_C = 80°C			12	A
P_{tot}	*total power dissipation*		T_C = 25°C			63	W
$V_{CE(sat)}$	*collector emitter saturation voltage*	I_C = 9 A; V_{GE} = 15 V	T_{VJ} = 25°C		1.8	2.1	V
			T_{VJ} = 125°C		2.1		V
$V_{GE(th)}$	*gate emitter threshold voltage*	I_C = 0.3 mA; V_{GE} = V_{CE}	T_{VJ} = 25°C	5	5.5	6.5	V
I_{CES}	*collector emitter leakage current*	V_{CE} = V_{CES}; V_{GE} = 0 V	T_{VJ} = 25°C		0.02	0.1	mA
			T_{VJ} = 125°C		0.2		mA
I_{GES}	*gate emitter leakage current*	V_{GE} = ±20 V				500	nA
$Q_{G(on)}$	*total gate charge*	V_{CE} = 600 V; V_{GE} = 15 V; I_C = 10 A			27		nC
$t_{d(on)}$	*turn-on delay time*	inductive load V_{CE} = 600 V; I_C = 10 A V_{GE} = ±15 V; R_G = 100 Ω	T_{VJ} = 125°C		70		ns
t_r	*current rise time*				40		ns
$t_{d(off)}$	*turn-off delay time*				250		ns
t_f	*current fall time*				100		ns
E_{on}	*turn-on energy per pulse*				1.1		mJ
E_{off}	*turn-off energy per pulse*				1.1		mJ
RBSOA	*reverse bias safe operating area*	V_{GE} = ±15 V; R_G = 100 Ω; V_{CEK} = 1200 V	T_{VJ} = 125°C			30	A
I_{SC} **(SCSOA)**	*short circuit safe operating area*	V_{CE} = 900 V; V_{GE} = ±15 V; R_G = 100 Ω; t_p = 10 µs; non-repetitive	T_{VJ} = 125°C		40		A
R_{thJC}	*thermal resistance junction to case*	(per IGBT)				2	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.7		K/W

Output Inverter D1 - D6

Symbol	Definitions	Conditions		min.	Ratings typ.	max.	Unit
V_{RRM}	*max. repetitve reverse voltage*		T_{VJ} = 25°C			1200	V
I_{F25}	*forward current*		T_C = 25°C			19	A
I_{F80}			T_C = 80°C			13	A
V_F	*forward voltage*	I_F = 10 A; V_{GE} = 0 V	T_{VJ} = 25°C		1.95	2.2	V
			T_{VJ} = 125°C		1.85		V
Q_{rr}	*reverse recovery charge*	V_R = 600 V di_F/dt = -250 A/µs I_F = 10 A; V_{GE} = 0 V	T_{VJ} = 125°C		1.2		µC
I_{RM}	*max. reverse recovery current*				9		A
t_{rr}	*reverse recovery time*				320		ns
E_{rec}	*reverse recovery energy*				0.4		mJ
R_{thJC}	*thermal resistance junction to case*	(per diode)				2.4	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.8		K/W

Brake T7

Symbol	Definitions	Conditions		min.	Ratings typ.	max.	Unit
V_{CES}	*collector emitter voltage*		T_{VJ} = 25°C			1200	V
V_{GES}	*max. DC gate voltage*	continuous				±20	V
V_{GEM}	*max. transient collector gate voltage*	transient				±30	V
I_{C25}	*collector current*		T_C = 25°C			17	A
I_{C80}			T_C = 80°C			12	A
P_{tot}	*total power dissipation*		T_C = 25°C			63	W
$V_{CE(sat)}$	*collector emitter saturation voltage*	I_C = 9 A; V_{GE} = 15 V	T_{VJ} = 25°C		1.8	2.1	V
			T_{VJ} = 125°C		2.1		V
$V_{GE(th)}$	*gate emitter threshold voltage*	I_C = 0.3 mA; V_{GE} = V_{CE}	T_{VJ} = 25°C	5	5.5	6.5	V
I_{CES}	*collector emitter leakage current*	V_{CE} = V_{CES}; V_{GE} = 0 V	T_{VJ} = 25°C		0.01	0.1	mA
			T_{VJ} = 125°C		0.1		mA
I_{GES}	*gate emitter leakage current*	V_{GE} = ±20 V				500	nA
$Q_{G(on)}$	*total gate charge*	V_{CE} = 600 V; V_{GE} = 15 V; I_C = 10 A			27		nC
$t_{d(on)}$	*turn-on delay time*	inductive load V_{CE} = 600 V; I_C = 10 A V_{GE} = ±15 V; R_G = 100 Ω	T_{VJ} = 125°C		70		ns
t_r	*current rise time*				40		ns
$t_{d(off)}$	*turn-off delay time*				250		ns
t_f	*current fall time*				100		ns
E_{on}	*turn-on energy per pulse*				1.1		mJ
E_{off}	*turn-off energy per pulse*				1.1		mJ
RBSOA	*reverse bias safe operating area*	V_{GE} = ±15 V; R_G = 100 Ω; V_{CEK} = 1200 V	T_{VJ} = 125°C			30	A
I_{SC} **(SCSOA)**	*short circuit safe operating area*	V_{CE} = 900 V; V_{GE} = ±15 V; R_G = 100 Ω; t_p = 10 µs; non-repetitive	T_{VJ} = 125°C		40		A
R_{thJC}	*thermal resistance junction to case*	(per IGBT)				2	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.7		K/W

Brake Chopper D7

Symbol	Definitions	Conditions		min.	Ratings typ.	max.	Unit
V_{RRM}	*max. repetitive reverse voltage*		T_{VJ} = 150°C			1200	V
I_{F25}	*forward current*		T_C = 25°C			12	A
I_{F80}			T_C = 80°C			8	A
V_F	*forward voltage*	I_F = 5 A; V_{GE} = 0 V	T_{VJ} = 25°C		1.95	2.2	V
			T_{VJ} = 125°C		1.85		V
I_R	*reverse current*	V_R = V_{RRM}	T_{VJ} = 25°C		0.01	0.1	mA
			T_{VJ} = 125°C		0.1		mA
Q_{rr}	*reverse recovery charge*	V_R = 600 V di_F/dt = 200 A/µs I_F = 5 A; V_{GE} = 0 V	T_{VJ} = 125°C		0.7		µC
I_{RM}	*max. reverse recovery current*				6		A
t_{rr}	*reverse recovery time*				320		ns
E_{rec}	*reverse recovery energy*				0.2		mJ
R_{thJC}	*thermal resistance junction to case*	(per diode)				3.4	K/W
R_{thCH}	*thermal resistance case to heatsink*				1.1		K/W

Input Rectifier Bridge D8 - D11

Symbol	Definitions	Conditions		Ratings min.	typ.	max.	Unit
V_{RRM}	*max. repetitive reverse voltage*		T_{VJ} = 25°C			1600	V
I_{FAV}	*average forward current*	sine 180°	T_C = 80°C			24	A
I_{DAVM}	*max. average DC output current*	rect.; d = $^1/_3$	T_C = 80°C			69	A
I_{FSM}	*max. forward surge current*	t = 10 ms; sine 50 Hz	T_{VJ} = 25°C			270	A
			T_{VJ} = 125°C			240	A
I^2t	*I^2t value for fusing*	t = 10 ms; sine 50 Hz	T_{VJ} = 25°C			360	A^2s
			T_{VJ} = 125°C			290	A^2s
P_{tot}	*total power dissipation*		T_C = 25°C			69	W
V_F	*forward voltage*	I_F = 30 A	T_{VJ} = 25°C		1.27	1.6	V
			T_{VJ} = 125°C		1.24		V
I_R	*reverse current*	$V_R = V_{RRM}$	T_{VJ} = 25°C			0.01	mA
			T_{VJ} = 125°C		0.3		mA
R_{thJC}	*thermal resistance junction to case*	(per diode)				1.8	K/W
R_{thCH}	*thermal resistance case to heatsink*	(per diode)			0.6		K/W

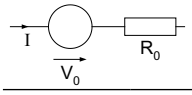
Temperature Sensor NTC

Symbol	Definitions	Conditions	Ratings min.	typ.	max.	Unit
R_{25}	*resistance*	T_C = 25°C	4.75	5.0	5.25	kΩ
$B_{25/50}$				3375		K

Module

Symbol	Definitions	Conditions	Ratings min.	typ.	max.	Unit
T_{VJ}	*operating temperature*		-40		125	°C
T_{VJM}	*max. virtual junction temperature*				150	°C
T_{stg}	*storage temperature*		-40		125	°C
V_{ISOL}	*isolation voltage*	$I_{ISOL} \leq$ 1 mA; 50/60 Hz			2500	V~
CTI	*comparative tracking index*				-	
F_C	*mounting force*		40		80	N
d_S	*creep distance on surface*		12.7			mm
d_A	*strike distance through air*		12			mm
Weight				35		g

Equivalent Circuits for Simulation



Symbol	Definitions	Conditions		Ratings min.	typ.	max.	Unit
V_0	*rectifier diode*	D8 - D13	T_{VJ} = 150°C			0.86	V
R_0						12.3	mΩ
V_0	*IGBT*	T1 - T6	T_{VJ} = 150°C			1.1	V
R_0						153	mΩ
V_0	*free wheeling diode*	D1 - D6	T_{VJ} = 150°C			1.09	V
R_0						91	mΩ
V_0	*IGBT*	T7	T_{VJ} = 150°C			1.1	V
R_0						153	mΩ
V_0	*free wheeling diode*	D7	T_{VJ} = 150°C			1.15	V
R_0						171	mΩ

IXYS reserves the right to change limits, test conditions and dimensions.

T_C = 25°C unless otherwise stated

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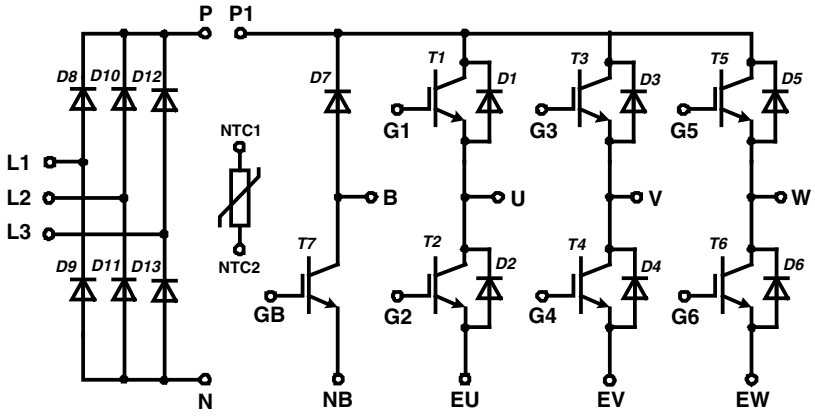
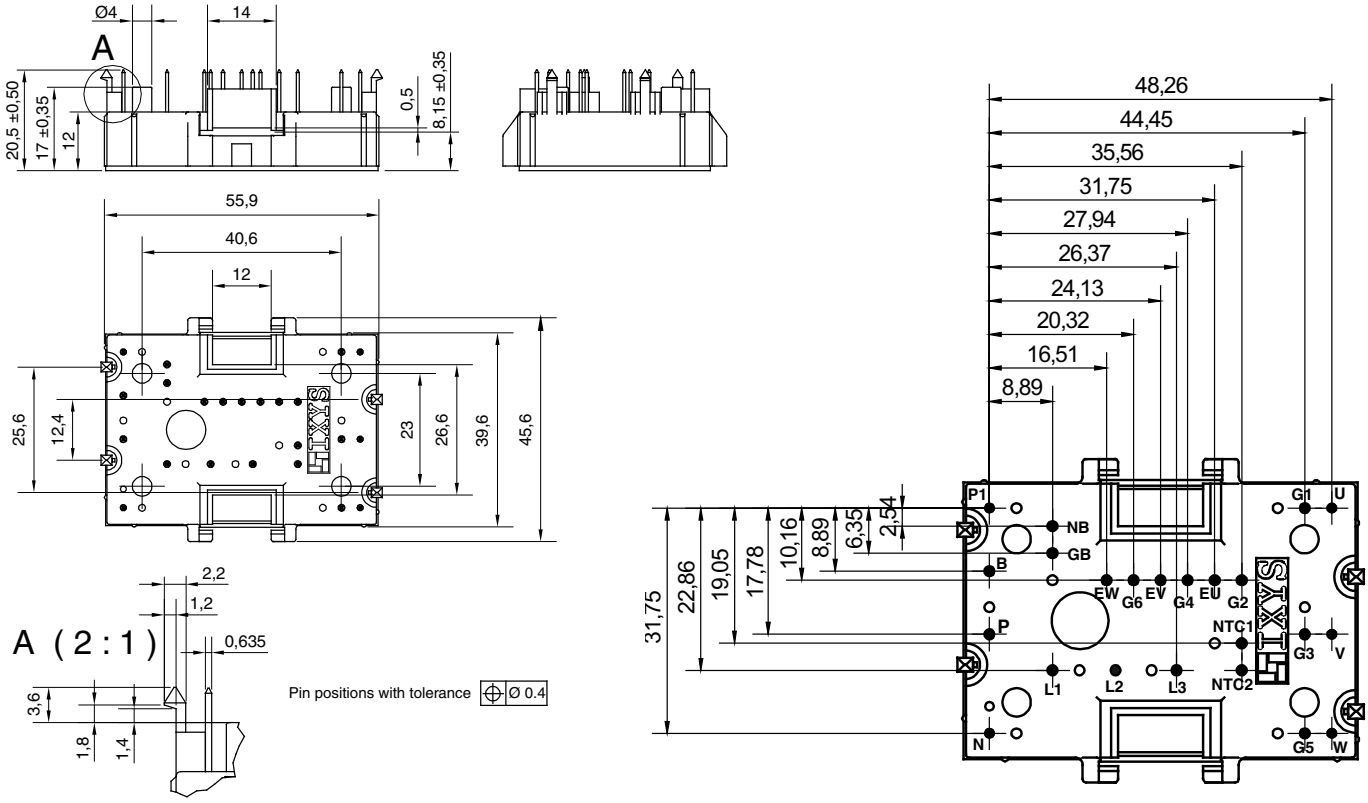
Circuit Diagram

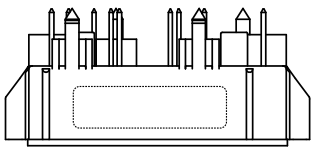


Outline Drawing

Dimensions in mm (1 mm = 0.0394“)



Product Marking



Part number

M = Module
I = IGBT
X = XPT
A = standard
20 = Current Rating [A]
WB = 6-Pack + 3~ Rectifier Bridge & Brake Unit
1200 = Reverse Voltage [V]
T = NTC
MH = MiniPack2

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MIXA 10 WB 1200 TMH	MIXA10WB1200TMH	Box	20	508609

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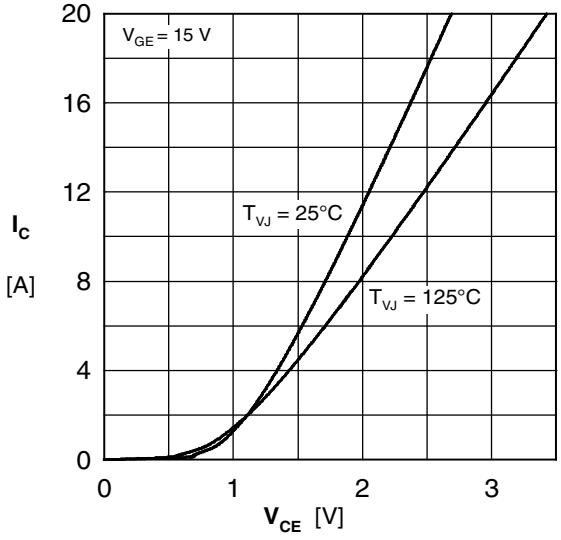

Fig. 1 Typ. output characteristics

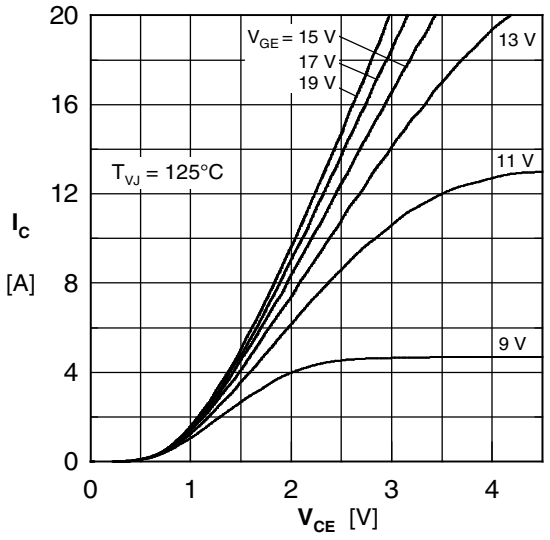

Fig. 2 Typ. output characteristics

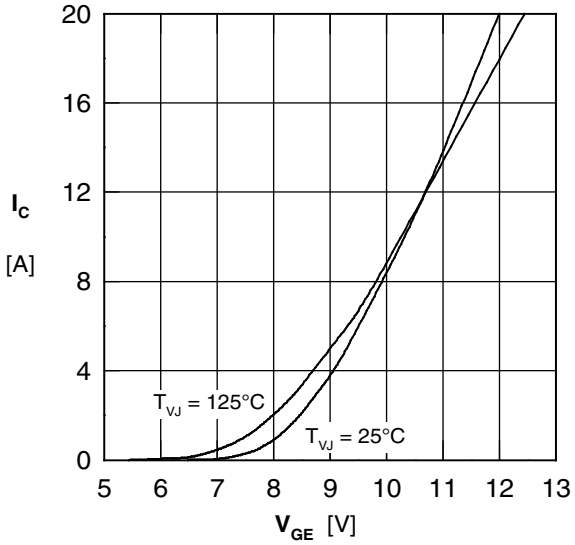

Fig. 3 Typ. tranfer characteristics

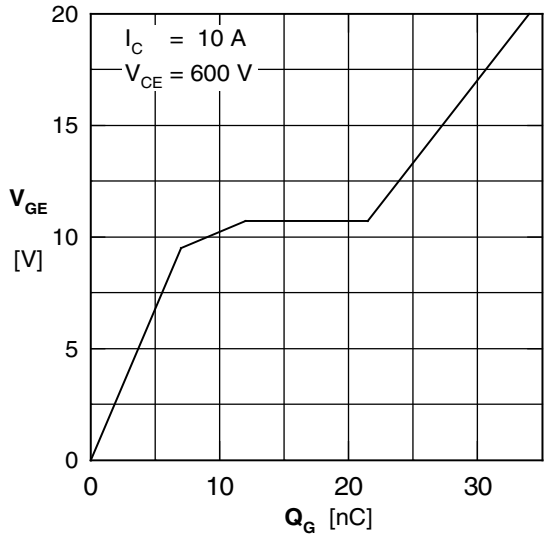

Fig. 4 Typ. turn-on gate charge

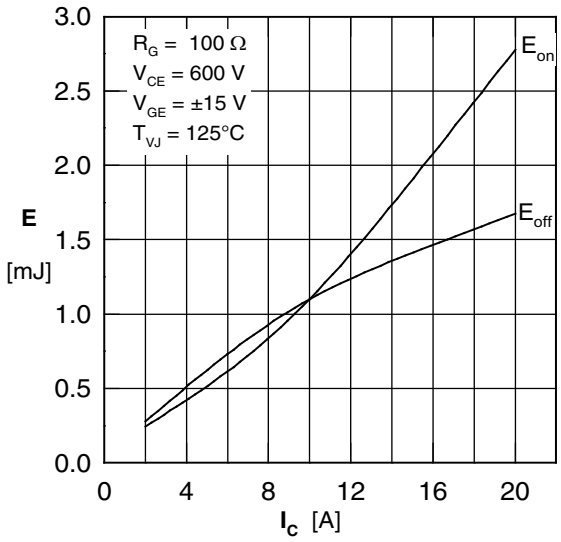

Fig. 5 Typ. switching energy vs. collector current

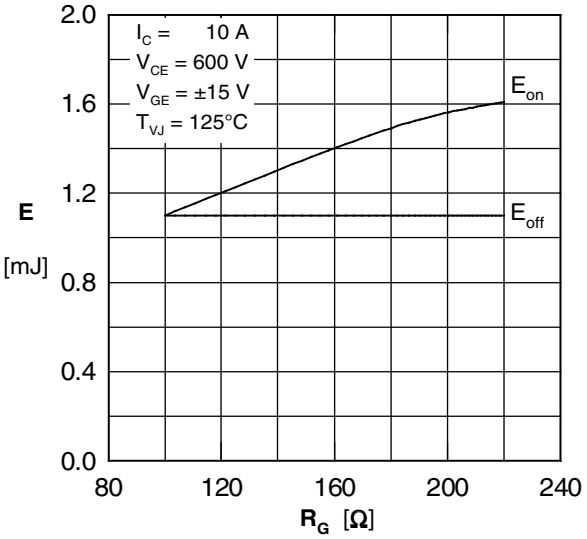

Fig. 6 Typ. switching energy vs. gate resistance

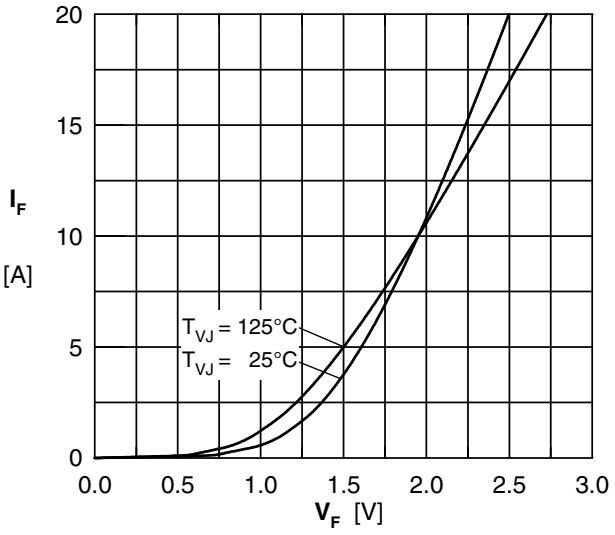

Fig. 7 Typ. forward characteristics

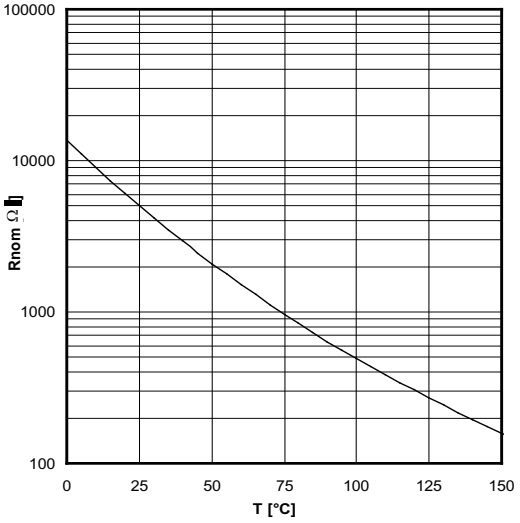

Fig. 8 Typ. thermistor resistance vs. temperature